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AKM Semiconductor Inc. AK8181B

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# Asahi**KASEI**

AK8181B



# 3.3V LVPECL 1:4 Clock Fanout Buffer AK8181B

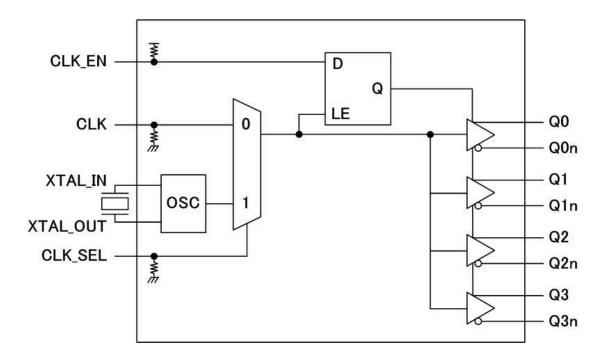
#### Features

- Four differential 3.3V LVPECL outputs
- Selectable LVTTL/LVCMOS CLK or crystal input
- Clock output frequency up to 266MHz
- Output skew : 10ps typical
- Part-to-part skew : 200ps maximum
- Propagation delay : 1.4ns maximum
- Additive phase jitter(RMS) : 0.057ps(typical)
- Operating Temperature Range: -40 to +85°C
- Package: 20-pin TSSOP (Pb free)
- Pin compatible with ICS8535I-31

# Description

The AK8181B is a member of AKM's LVPECL clock fanout buffer family designed for telecom, networking and computer applications, requiring a range of clocks with high performance and low skew. The AK8181B distributes 4 buffered clocks.

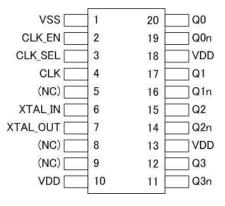
AK8181B are derived from AKM's long-termexperienced clock device technology, and enable clock output to perform low skew. The AK8181B is available in a 20-pin TSSOP package.



## Block Diagram



## **Pin Descriptions**



#### Package: 20-Pin TSSOP (Top View)

Pin No.	Pin Name	Pin Type	Pullup down	Description
1	VSS	PWR		Negative power supply
2	CLK_EN	IN	Pull up	Synchronizing clock output enable (LVCMOS/LVTTL) Pin is connected to VDD by internal resistor. (typ. $51k\Omega$ ) High (Open): clock outputs follow clock input. Low: Q outputs are forced low, Qn outputs are forced high.
3	CLK_SEL	IN	Pull down	CLK Select Input (LVCMOS/LVTTL) Pin is connected to VSS by internal resistor. (typ. $51k\Omega$ ) High: selects XTAL input Low (Open): selects CLK input
4	CLK	IN	Pull down	LVCMOS/LVTTL Clock Input Pin is connected to VSS by internal resistor. (typ. 51kΩ) *When using crystal input (CLK_SEL=High), it should be connected to VSS or opened.
5	NC			No connect
6	XTAL_IN	IN		Crystal oscillator interface *When using CLK input (CLK_SEL=Low), it should be connected to VSS or opened.
7	XTAL_OUT	OUT		Crystal oscillator interface *When using CLK input (CLK_SEL=Low), it should be connected to VSS or opened.
8	NC			No connect
9	NC	-		No connect
10	VDD	PWR		Positive power supply
11, 12	Q3n, Q3	OUT		Differential clock output (LVPECL)
13	VDD	PWR		Positive power supply
14, 15	Q2n, Q2	OUT		Differential clock output (LVPECL)
16, 17	Q1n, Q1	OUT		Differential clock output (LVPECL)
18	VDD	PWR		Positive power supply
19, 20	Q0n, Q0	OUT		Differential clock output (LVPECL)

# **Ordering Information**

Part Number	Marking	Shipping Packaging	Package	Temperature Range
AK8181B	AK8181B	Tape and Reel	20-pin TSSOP	-40 to 85 °C









#### **Absolute Maximum Rating**

Over operating free-air temperature range unless otherwise noted <sup>(1)</sup>	

Items	Symbol	Ratings	Unit
Supply voltage <sup>(2)</sup>	VDD	-0.3 to 4.6	V
Input voltage <sup>(2)</sup>	Vin	-0.5 to VDD+0.5	V
Input current (any pins except supplies)	I <sub>IN</sub>	±10	mA
Storage temperature	Tstg	-55 to 150	°C

Note

(1) Stress beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only. Functional operation of the device at these or any other conditions beyond those indicated under "Recommended Operating Conditions" is not implied. Exposure to absolute-maximum-rating conditions for extended periods may affect device reliability. Electrical parameters are guaranteed only over the recommended operating temperature range.

(2) VSS=0V



## **ESD Sensitive Device**

This device is manufactured on a CMOS process, therefore, generically susceptible to damage by excessive static voltage. Failure to observe proper handling and installation procedures can cause damage. AKM recommends that this device is handled with appropriate precautions.

#### **Recommended Operation Conditions**

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Operating temperature	Та		-40		85	°C
Supply voltage <sup>(1)</sup>	VDD	VDD±5%, VSS=0V	3.135	3.3	3.465	V

(1) Power of 3.3V requires to be supplied from a single source. A decoupling capacitor of 0.1µF for power supply line should be located close to each VDD pin.

#### **Pin Characteristics**

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Input Capacitance	C <sub>IN</sub>			4		pF
Input Pullup Resistor	R <sub>PU</sub>			51		kΩ
Input Pulldown Resistor	R <sub>PD</sub>			51		kΩ





#### **DC Characteristics**

All specifications at VDD= 3.3V±5%, VSS=0V, Ta: -40 to +85°C, unless otherwise noted

	Parameter	Symbol	Conditions	MIN	ТҮР	МАХ	Unit
Input High Volt	age	VIH		2.0		VDD+0.3	V
Input Low Volta	age	VIL		-0.3		0.8	V
Input	CLK, CLK_SEL		Vin=VDD=3.465V			150	μA
High Current	CLK_EN	Ін	Vin=VDD=3.465V			5	μA
Input	CLK, CLK_SEL		Vin=VSS, VDD=3.465V	-5			μA
Low Current	CLK_EN	- I <u>L</u>	Vin=VSS, VDD=3.465V	-150			μA
Output High V	/oltage <sup>(1)</sup>	V <sub>OH</sub>		VDD-1.4		VDD-0.9	V
Output Low V	oltage <sup>(1)</sup>	V <sub>OL</sub>		VDD-2.0		VDD-1.7	V
Peak-to-Peak Voltage Swing	•	V <sub>SWING</sub>		0.6		1.0	V
Supply Currer	nt	I <sub>DD</sub>				60	mA

(1) Outputs terminated with  $50\Omega$  to VDD-2V.

# **Crystal Characteristics**

All specifications at VDD= 3.3V $\pm$ 5%, VSS=0V, Ta: -40 to +85°C, unless otherwise noted

Parameter	Conditions	MIN	ТҮР	МАХ	Unit
Mode of Oscillation		F	undament	al	
Frequency		12		50	MHz
Equivalent Series Resistance (ESR)				50	Ω
Shunt Capacitance				7	pF
Drive Level				1	mW





#### **AC Characteristics**

All specifications at VDD= 3.3V±5%, VSS=0V, Ta: -40 to +85°C, unless otherwise noted

Parameter	Symbol	Conditions	MIN	ТҮР	МАХ	Unit
Output Frequency	f <sub>оит</sub>				266	MHz
Propagation Delay <sup>(1)</sup>	t <sub>PD</sub>		0.6		1.4	ns
Output Skew <sup>(2)(3)</sup>	t <sub>sk(O)</sub>			10		ps
Part-to-Part Skew <sup>(3)(5)</sup>	t <sub>skPP</sub>				200	ps
Buffer Additive Jitter, RMS	t <sub>jit</sub>	155.52MHz (12kHz – 20MHz)		0.057		ps
Output Rise/Fall Time <sup>(4)</sup>	t <sub>r</sub> , t <sub>f</sub>	20% to 80%	200		600	ps
Output Duty Cycle	DCOUT		46	50	54	%

(1) Measured from the VDD/2 of the input to the differential output crossing point.

(2) Defined as skew between outputs at the same supply voltage and with equal load conditions.

(3) This parameter is defined in accordance with JEDEC Standard 65.

(4) Design value.

(5) Defined as skew between outputs on different devices operating at the same supply voltages and with equal load conditions. Using the same type of inputs on each device, the outputs are measured at the differential cross points.



**Distributor of AKM Semiconductor Inc.: Excellent Integrated System Limited** Datasheet of AK8181B - IC CLK BUFFER 2:4 20TSSOP Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

#### AK8181B



#### **Parameter Measurement Information**

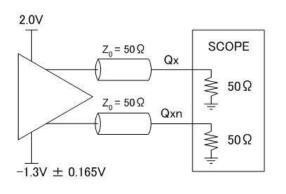


Figure 1 3.3V Output Load Test Circuit

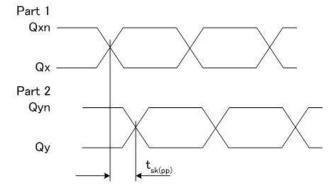
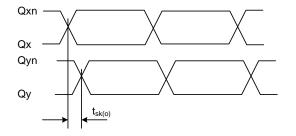
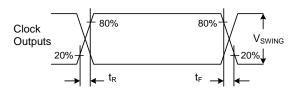
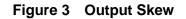


Figure 2 Part-to-Part Skew









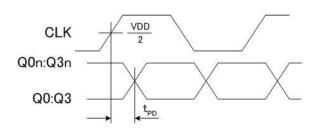
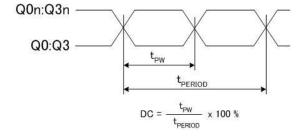
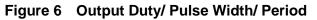


Figure 5 Propagation Delay









## **Function Table**

The following table shows the inputs/outputs clock state configured through the control pins.

	Inputs		Outputs				
CLK_EN	CLK_SEL	Selected Source	Q0:Q3	Q0n:Q3n			
0	0 (Open)	CLK	Disabled: Low	Disabled: High			
0	1	XTAL_IN, XTAL_OUT	Disabled: Low	Disabled: High			
1 (Open)	0 (Open)	CLK	Enabled	Enabled			
1 (Open)	1	XTAL_IN, XTAL_OUT	Enabled	Enabled			

#### **Table 1: Control Input Function Table**

After CLK\_EN switches, the clock outputs are disabled or enabled following a rising and falling input clock or crystal oscillator edge as shown in Figure 7. In the active mode, the state of the outputs are a function of the CLK input as described in Table 2.

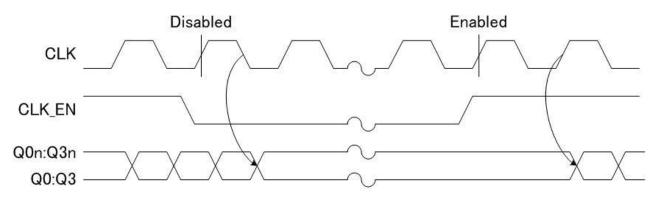


Figure 7	CLK_	EN	Timing	Diagram
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Inputs	Outputs			
CLK	Q0 : Q3	Q0n : Q3n		
0	Low	High		
1	High	Low		

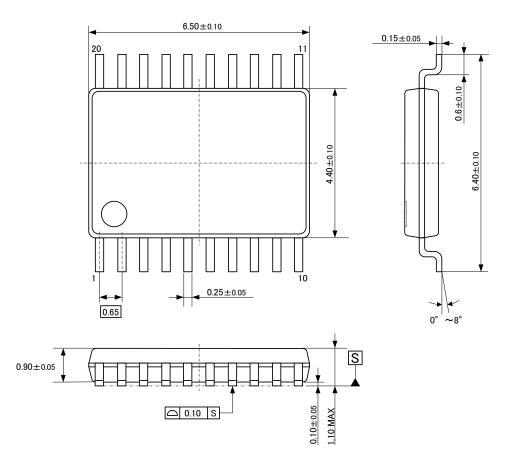
#### **Table 2 Clock Input Function Table**



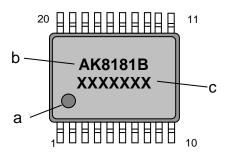


#### **Package Information**

• Mechanical data : 20pin TSSOP



• Marking



- a: #1 Pin Index
- b: Part number
- c: Date code (7 digits)

## RoHS Compliance



All integrated circuits form Asahi Kasei Microdevices Corporation (AKM) assembled in "lead-free" packages\* are fully compliant with RoHS.

(\*) RoHS compliant products from AKM are identified with "Pb free" letter indication on product label posted on the anti-shield bag and boxes.





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